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Synthesis and Characterization of Ultralong Copper Sulfide Nanowires and their Electrical Properties

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Abstract

We report the synthesis of ultralong copper sulfide nanowires (Cu_{2-x}SNWs) through the sulphidation reaction of metallic copper nanowires (CuNWs) by thiourea in mild conditions. The multiscale characterization of Cu_{2-x}SNWs revealed the presence of a core shell structure made by an external covellite layer coating a roxbyite core. The Cu_{2-x}SNWs, exhibiting lengths as high as 200 μ m, can be easily dispersed in ethanol and deposited onto arbitrary substrates such as glass or plastic. The resulting films are readily conducting without need of post- treatments and exhibit a sheet resistance of 4.1 kΩ/sq at 73.7 % transmittance (at 550 nm), by virtue of the high aspect ratio of the Cu_{2-x}SNWs. The multiscale electrical characterization down to the single Cu_{2-x}SNWs revealed a low resistivity of 6.9×10^{-6} Ω·m and perfectly Ohmic conduction. Interestingly, the conductivity of Cu_{2-x}SNWs films supported on polyethylene naphthalate sheets remained almost unaltered (4 % decrease) after 10000 bending cycles. In addition, Cu_{2-x}SNWs have shown an excellent chemical stability towards a strong oxidant like FeCl₃ as well as in acidic environment. Finally, Cu_{2-x}SNWs have been employed as active materials in symmetric supercapacitors revealing good pseudocapacitive behaviour, with specific capacity as high as 324 F·g⁻¹ (at 5 mV·s⁻¹) and 70 % retention of the initial capacitance after 5000 cycles (at 100 mV·s⁻¹).

1 Introduction

The ever-growing flexible, wearable electronics markets require a constant supply of conducting materials that can be processed at low-cost, on large-area and on various flexible substrates. Furthermore, for opto-electronic applications, transparency of thin conductive films is a coveted feature, e.g. due to the widespread request of curved/ foldable screens. Beyond carbon-based nanomaterials such as carbon nanotubes¹ or graphene,² metal nanowires have been considered as the next generation of flexible transparent conductors.³ Indeed, the high aspect ratio of metal nanowires allows them to exhibit a relatively low percolation threshold, which is beneficial for the fabrication of thin film conductive layers and devices for transparent electronics⁴ with enhanced mechanical properties. Among them, copper nanowires (CuNWs) has gained increasing attention in the last decade as they can be readily synthesized at extremely low cost and exhibit high processability.⁵ Furthermore, in view of the high transparency of the obtained CuNWs films, performance comparable to commercially available transparent conductive oxides such as indium tin oxide (ITO) can be reached. Regrettably, CuNWs are prone to oxidation, which limits their technological applications. In particular, the as-synthesized CuNWs exhibit native insulating oxide layer that needs to be removed to allow efficient charge percolation through CuNWs films and networks. Many efforts have been devoted to improve the electrochemical stability of copper through the formation of alloys,⁶ or by coating it protective shells.⁷ Unfortunately, such strategies require a post-processing of the material that not only increases the production cost, but could be incompatible with chemically fragile substrates such as paper or plastic. Therefore, it is of interest to obtain a material that can be used as an ink to be readily deposited onto an arbitrary substrate without any further treatment. In this regard copper sulfide, which has a general formula Cu_{2-x}S, appears particularly appealing as it displays a remarkable chemical stability, while its electronic properties not only depend on the Cu:S ratio, but also on its morphology at the nanoscale.⁸ Currently, Cu_{2-x}S is explored in a wide range of applications including solar cells, photocatalysis, biosensors, optoelectronic and is employed as a cathode material in lithium rechargeable batteries.⁹

Herein, we investigate the possibility to convert the native oxide layer (Cu_xO_y) present on the CuNWs surface to copper sulfide (Cu_{2-x}S) while keeping the same high aspect ratio of the unmodified CuNWs to obtain a stable material that can be disperse and directly deposited onto a substrate without the need of any post deposition treatment. The resulting Cu_{2-x}SNWs have been in-depth characterized with a wide range of physicochemical techniques to determine their composition and properties. The conductivity of the Cu_{2-x}SNWs films has been correlated with the optical transparency, to evaluate their possible use as transparent conductors, and through bending test experiments to verify their adequacy in flexible electronics. The chemical stability of Cu_{2-x}SNWs have been verified versus known copper etchant such as FeCl₃, HCl and NaOH. Finally, the Cu_{2-x}SNWs have been exploited as active material in a solid-state symmetric supercapacitor revealing pseudocapacitive behavior and promising electrochemical performances.

2 Materials and methods

2.1 Cu_{2-x}S Nanowires (NWs) synthesis

First, CuNWs were synthesized following a modification of an existing method.¹⁰ To this end 380 mg of CuCl₂·2H₂O and 2.6 g of octadecylamine were dissolved in 110 mL of deionized water. The suspension was sonicated until a light blue emulsion was obtained. Then 850 mg of glucose were added and the emulsion was stirred at 60 °C for 3 hours to homogenize the emulsion. Finally, the emulsion was transferred to a steel autoclave and heated to 115 °C for 16 hours. The resulting CuNWs were isolated from the reaction suspension by centrifugation firstly with water, then with ethanol/water mixture 1/1, and finally with pure ethanol (4500 rpm, 8 min).

To synthesize the $Cu_{2-x}SNWs$, thiourea (137 mg) and $CuCl_2 \cdot 2H_2O$ (0.0 or 1.0 mg) were dissolved in 55 mL of ethanol (or 55 mL of water). Then, 5 mL of CuNWs ethanolic suspension (1.2 mg·mL⁻¹) were added to the solution and this was sonicated for 2 min to obtain a homogenous dispersion. Finally, the solution was heated at 80 °C without stirring for 2 hours. The obtained $Cu_{2-x}SNWs$ were then washed several times by centrifugation from ethanol to remove the excess of thiourea (5000 rpm, 10 min) and finally dispersed in 40 mL ethanol.

2.2 Preparation of transparent conductive substrates based on Cu_{2-x}SNWs

The Cu_{2-x}SNWs ethanolic dispersion was further diluted 20 times in ethanol, sonicated for 2 min and finally spray-coated with a commercial airbrush onto freshly cleaned soda lime glass slides, polyethylene terephthalate (PET) and polyethylene naphthalate (PEN) substrates (125 μ m thick). To assess the transparency of the film as a function of its sheet resistance, increasing amounts of NWs dispersion were coated onto the substrates.

2.3 Single Cu_{2-x}S Nanowire device fabrication

A diluted suspension of $Cu_{2-x}SNWs$ in ethanol was sonicated for 5 min and then drop-casted onto a freshly cleaned Si/SiO₂ substrate with patterned gold markers. Then, the single $Cu_{2-x}SNW$ devices were patterned by direct laser lithography (AZ1505 photoresist and MIF726 developer, Micro Chemicals GmbH, Italy) using the laser writer LW405B (Microtech srl, Italy). Afterwards, a uniform gold layer (60 nm) was deposited on top by vacuum thermal evaporation, followed by a lift-off process in warm acetone (50 °C) to remove the unexposed photoresist and obtain the final source and drain electrodes.

2.4 Assembly of the supercapacitor

The working electrodes were prepared by mixing Cu_{2-x}SNWs (80% wt%, 8 mg), carbon black (10wt%, 1 mg) and poly(tetrafluoroethylene) (PTFE) (10wt%, 1 mg) in 2-3 drops of *N*-Methyl-2-pyrrolidone. The paste was then deposited on carbon foil substrate and dried under vacuum (80° C). The electrodes were assembled in coin cell (CR2032) using Whatman[®] glass microfiber filters as a separator using drop of electrolyte 1-Ethyl-3-methylimidazolium bis(trifluoromethylsulfonyl)imide in polycarbonate 1M.

3 Results

The copper sulfide nanowires ($Cu_{2-x}SNWs$) were synthesized by sulphidation of high-quality CuNWs. We employed a facile procedure in which thiourea was used as a source of sulfur, instead of the more

toxic and reactive Na₂S. In particular, the CuNWs were treated with a diluted ethanolic solution of thiourea heated at 80 °C for two hours. Heating is necessary to activate the reaction with thiourea,¹¹ the conversion of the CuNWs into Cu_{2-x}SNWs is made possible by the thin layer of CuO which coats the synthesized CuNWs.¹⁰ In Figure 1a-b displays optical micrograph and scanning electron microscopy (SEM) images of the nanowires. They reveal that the NWs preserve a high aspect ratio, with lengths in the range $20 - 200 \,\mu\text{m}$ and an average diameter of 98 ± 17 nm as determined on 105 individual wires. Interestingly, when the reaction was conducted in water instead of ethanol, a fragmentation of the nanowires, with consequent reduction of the aspect-ratio, was observed (Figure S1 of the SI). Magnified SEM image (Figure 1c) depicts that the surface of the nanowire is covered by nanoplates of copper sulfide. The transmission electron microscopy (TEM) image shows that the nanowires present a core-shell structure, with a darker contrast in the outer shell and brighter one in the center (Figure 1d). In addition, the high-resolution TEM (HRTEM) image (Figure 1e) displays characteristic lattice fringes that demonstrate the presence of crystallized structures associated to grains with various morphologies and orientations with sizes of 10-20 nm. The polycrystalline composition of the Cu₂. xSNWs is confirmed also by selected area electron diffraction (SAED) pattern (Figure 1f), which exhibits the combination of discrete spots and concentric rings.



Figure 1. (a) Optical micrograph, (b-c) SEM, (d) TEM, (e) HRTEM images of the synthesized Cu_{2-x}SNWs. (f) SAED pattern of the area in (e), highlighting the presence of crystallized grains and the polycrystalline feature of the chosen area

The chemical composition of the nanowires was investigated by both Energy dispersive X-Ray Analysis (EDX) and X-Ray Photoelectron spectroscopy. The EDX mapping provided evidence for the presence of both copper and sulfur on all the nanowire section, with no appreciable differences between the outer and inner part (Figure S2a of the SI) while EDX spectrum shows the presence of copper and sulfur, in addition to small quantities of carbon, nitrogen and oxygen, with a Cu:S ratio of 1.57 (Figure S2 b of the SI). The fitting of the survey spectra of XPS analysis (Figure S3 of the SI) provides a similar Cu:S ratio of 1.55. Figure 2a portrays a high-resolution spectrum of Cu 2p peak of the copper sulfide nanowires. The Cu 2p_{3/2} peak has a chemical shift of 932.4 eV, which is representative of Cu(I) of both

CuS and Cu₂S.¹²⁻¹³ The broad peaks at 945 and 963 eV are weak satellite peaks, which can be likely ascribed to some Cu^{2+} surface impurities, while the pronounced tails of $Cu 2p_{3/2}$ and $2p_{1/2}$ are due to the metallic properties of copper sulphides.¹³ The Cu LMM Auger peak (Figure S4 of the SI) falls at 568.7 eV, which is a typical value for CuS.¹⁴ Figure 2b depicts the deconvoluted peak of Sp. Each component of the spectrum is split in two peaks ($p_{3/2}$ and $p_{1/2}$) for the spin-orbit coupling ($\Delta e = 1.16$ eV). The components at 161.3 and 162.8 eV belong to the species S²⁻ and S₂²⁻ which can be found in all copper sulphides.¹⁵⁻¹⁶ Another split component is visible at 167.9 eV and is due to some sulfate (probably from decomposition of thiourea) present on the surface of the nanowires. The Raman spectrum (Figure 2c) further confirms the composition of the nanowires; in fact, the intense peak at 473 cm⁻¹ is due to S-S stretching and the weaker peak at 264 cm⁻¹ belongs to Cu-S vibration.¹⁷⁻¹⁸ In particular, the peak shifts are characteristics of the covellite (CuS) structure.¹⁹ The presence of covellite phase is confirmed also by X-Ray powder diffraction (XRD). Moreover, the diffractograms of the nanowires evidence the presence of also another crystalline phase, which can be identified as roxbyite (Cu_{1.8}S).²⁰⁻²¹ The presence of two crystalline phases would explain also why the stoichiometric ratio Cu:S measured was 1.55. Furthermore, the absence of the Cu(111) peak at $2\theta = 43.3^{\circ}$ and Cu(200) peak at 50.4°, which are typical of metallic CuNWs, indicates a total conversion of the copper(0) in Cu₂-_xS.²²⁻²³ To confirm the core-shell structure of the Cu_{2-x}SNWs, we acquired the XPS spectra of the nanowires while etching their surface with an argon ion beam. It is possible to see that the peaks belonging to sulfate at 168 eV in the S 2p spectra (Figure S5a of the SI) and the satellite peaks due to Cu^{2+} in the Cu 2p spectra (Figure S5b of the SI) disappear already after the first etching cycle, thus confirming that the contamination involves just a thin layer of the surface. Similarly, the foreign elements C, N and O also disappear after the first etching cycles (Figure S5c of the SI). Moreover, the atomic abundance ratio between Cu and S increases from 1.04 to 1.72 with increasing the etching time (Figure S5d of the SI), thus supporting the hypothesis of core-shell nanowires composed by an outer core of covellite and an inner core of roxbyite.

The absorption spectra of the $Cu_{2-x}SNWs$ dispersed in ethanol was used to evaluate the optical bandgap (Figure S6 of the SI). The nanowires exhibit a maximum of absorbance at 397 nm. The energy of the optical direct and indirect bandgaps, computed from the Tauc plot (Figure S7 of the SI) amount to 2.0 eV and 1.27 eV respectively, in line with reported values for CuS and $Cu_{1.8}S.^{24-25}$ We also measured the ionization potential (IP) of the $Cu_{2-x}SNWs$ deposited on a Si/SiO₂ substrate by photoemission spectroscopy in air (Figure S8 of the SI) which resulted 4.80 ± 0.02.



Figure 2. Characterization of the chemical composition. XPS spectra of (a) Cu 2p and (b) S p of Cu_{2-x}SNWs. (c) Raman spectrum, and (d) XRD powder diffractogram of $Cu_{2-x}SNWs$.

The Cu_{2-x}SNWs were then tested as transparent conductive films. The nanowires could be uniformly deposited onto glass, plastic, and paper substrates readily from ethanolic dispersion by using a commercial airbrush. Interestingly, the films were already conductive, immediately after the spray-deposition, without needing any post-treatment such as annealing under reducing atmosphere or chemical reduction. We tested the I-V characteristic of a conductive Cu_{2-x}SNWs film deposited on a 5x1.5 cm² foil of polyethylene naphthalate (PEN) 125 μ m thick by connecting two electrodes made with copper tape. The film presented a perfectly Ohmic conductivity, with a resistance of 3.8 kΩ (figure S9 of the SI). Then, we tested the flexibility of the film, by performing 10000 bending cycles with a bending radius of 8 mm (Figure S10 of the SI). The resistance of the film revealed an increase of only 4.4 % after 10000 bending cycles. We also manually tested the static bending of the film with different radii (Figure 3a). No appreciable changes in the resistance were detected up to 1 cm of bending radius, followed by an increase of the resistance, which reaches 4.7 % at a bending radius of 2.5 mm.

Subsequently, we spray-coated different amounts of $Cu_{2-x}SNWs$ dispersed in ethanol onto glass substrates, and we measured the sheet resistance and transmittance of the films. The measured sheet resistance of the films as a function of their transmittance at 550 nm is reported in Figure 3b. The corresponding transmittance spectra, photos and microphotographs of the conductive films are reported in Figure S11 of the SI. The sheet resistance decreases by several orders of magnitude passing from 90 % transmittance to 80 %. At 73.7 % of transmittance (at 550 nm) the sheet resistance of the film is 4.1 k Ω /sq, hence being around 50-100 times higher than for films of CuNWs after annealing or

chemical reduction.^{5, 10, 26} Thick films made by filtration ($34\pm4 \mu m$ thick) presented a sheet resistance of $15\pm2 \Omega$ /sq which corresponds to a bulk resistivity of $5\times10^{-4} \Omega \cdot m$. However, compared to CuNWs, these copper sulfide nanowires display a much higher chemical stability, in particular to acid and oxidative environments. Spray coated films of Cu_{2-x}SNWs onto glass substrates were soaked into a FeCl₃ 50 mM, HCl 1 M and NaOH 1 M solutions for 24 hours at room temperature (Figure 3c). The sheet resistance of the film exposed to the oxidizing FeCl₃ increased of 15 times over 24 hours, while the sheet resistance of the film exposed to acidic environment presented a 3-fold increase over 24 hours. In both cases the transmittance (at 465 nm) of the films after 24 h increased of ca. 6 % because of the corrosion (Figure S12a-c of the SI). In comparison, films of CuNWs on glass were completely dissolved by FeCl₃ and HCl in less than 30 seconds and 5 min of exposure, respectively. Nevertheless, the stability of the Cu_{2-x}SNWs to NaOH 1M was lower, with complete loss of the conductivity and dissolution of the film after 4 hours of exposure (Figure S12d of the SI).

We have annealed the film under nitrogen at different temperatures to evaluate the effect of the annealing on the conductivity of the film. We noticed a 2-fold decrease of the sheet resistance of the film (from 1.24±0.07 kΩ/sq to 632±28 Ω/sq) after 30 min of annealing at 190 °C. To check if this decrease in resistance was due to a crystal phase transition, we performed differential scanning calorimetry (DSC) on the Cu_{2-x}SNWs under nitrogen flux (Figure S13a of the SI). We found an endothermic peak at 189 °C, which can be ascribed to a crystal phase transition. However, XPS analysis performed after the annealing suggests that the increase in conductivity may be due to desorption of the contaminants and removal of the surface oxidized layer (Figure S14 of the SI). The thermogravimetric analysis of the nanowires made it possible to assess their thermal stability in air (Figure S13b of the SI). The Cu_{2-x}SNWs present a steep mass loss at 275 °C, probably determined by the conversion of the external CuS into Cu₂S and release of SO₂, followed by a first increase of mass (+23 %) at 305 °C, due to oxidation to copper sulfate, and a second increase of mass (+6 %) at 480 °C, due to formation of CuO·CuSO₄. Finally, at 550 °C the mass starts to decrease because of the conversion to CuO and release of SO₂.²⁷

The electrical characterization was performed also on a single Cu_{2-x}SNW. We evaporated two gold top electrodes on a single Cu_{2-x}SNW by direct laser lithography (Figure S15 of the SI). Also in this case, the conduction was perfectly Ohmic (Figure 3d). The measured resistance of the single wire amounted to 16.9±0.1 kΩ. The length and diameter of the nanowire were measured by SEM and resulted in 18.1±0.3 µm and 97.6±3.3 nm. This made it possible to calculate the resistivity of the single nanowire, which was resulted $6.9 \times 10^{-6} \Omega \cdot m$. The lower value compared to the bulk resistivity can be attributed to the absence of the contact resistance between nanowires in the single nanowire measurement. For



comparison, a single CuNW of similar aspect ratio has been reported having a resistivity 43 times lower.²⁸

Figure 3. (a) Change in sheet resistance of a 5x1.5 cm² conductive film of spray-coated $Cu_{2-x}SNWs$ on PEN (125µm) as a function of the bending radius. (b) Sheet resistance of spray-coated $Cu_{2-x}SNWs$ on glass as a function of their transmittance at 550 nm. (c) Sheet resistance 3 different films of spray-coated $Cu_{2-x}SNWs$ on glass as function of soaking time into water solutions of HCl 1M (black curve), FeCl₃ 50mM (red curve) and NaOH 1M (blue curve). Current as a function of the potential applied to a single $Cu_{2-x}SNW$.

Copper sulfide nanostructures were found being promising electrode materials for supercapacitors.²⁹ Since Cu_{2-x}SNWs could benefit from their large specific surface area, we tested them as electrode material for supercapacitors. The Cu_{2-x}SNWs were deposited on a carbon foil substrate and used as electrodes in a solid-state symmetric supercapacitor in which 1-Ethyl-3-methylimidazolium bis(trifluoromethylsulfonyl)imide 1M in polycarbonate was used as electrolyte. The use of an organic electrolyte and of an aprotic ionic liquid allowed to extend the potential window up to 2.5 V. We performed cyclic voltammetry (CV) analyses between 0 and 2.5 V at different scan rates, ranging from 5 mV·s⁻¹ to 2000 mV·s⁻¹ (Figure 4a and Figure S16 of the SI). The analysis of curves at lower scan rates clearly depicts pseudocapacitive behaviour indicating a significant contribution of Faradaic reactions in storage mechanism (Figure 4b). The presence of peaks around 1.0 and 1.5 V can be attributed to oxidation between Cu_{1.8}S and CuS, followed by the oxidation of S⁻ to S^{0.30-32} At higher scan rates the redox peaks become less pronounced and the curves acquire a quasi-rectangular shape, indicating that the capacitance of the pseudocapacitor becomes dominated by the double-layer effect, due to the fast polarization of electrolyte ions on electrodes surfaces. The slow diffusion of the large electrolyte ions into the nanostructured electrode is responsible of the diminished Faradaic

component. The highest specific capacitance of 324 F·g⁻¹ was obtained at scan rates of 5 mV·s⁻¹, which is similar to the one of a previously reported solid state supercapacitor based on Cu₇S₄ NWs.³³ The volumetric capacitance and energy density of the electrode were estimated as 60.5 F·cm⁻³ and 52.5 mWh cm⁻³, respectively (at scan rates of 5 mV \cdot s⁻¹). To the best of our knowledge these values are the highest reported for supercapacitors based on copper sulfides nanostructures.³⁴⁻³⁶ However, due to the slow diffusion of the electrolyte, the material shows an important drop of the specific capacity at higher scan rates (40.3 F·g⁻¹ at 1000 mV·s⁻¹) (Figure 4c and Table S1 of the SI). Notably, the material exhibited moderate capacitance retention of 70% of initial capacitance, dropping from 91.3 $F \cdot g^{-1}$ to 64 F·g⁻¹ after 5000 cycles while tested at 100 mV·s⁻¹ (Figure 4d and Figure S17a of the SI), which is comparable to similar copper sulfides nanostructures.³⁰⁻³¹ Such a drop mainly occurs during the first 1000 cycles, and it is followed by a stabilization of the capacitance, thus suggesting the formation of an irreversibly oxidized passivation layer which protects the rest of the active material. The distorted shape of GCD curves (Figure S17b of the SI) also confirms pseudocapacitive behavior which can be additionally supported by redox active electrolyte which was previously reported for bis(trifluoromethylsulfonyl)imide anion.³⁷ The Nyquist plot (Figure S17c of the SI) revealed solution resistance of 5.8 Ω , comparable with other ionic liquid electrolyte- based devices³⁸⁻³⁹ and the Warburg resistance of 25 Ω corresponding to ion transfer on electrolyte- Cu_{2-x}SNWs electrode interface and suggests that dense packing of nanowires might slightly restrict easy ion migration through the electrode.30



Figure 4. (a) Cyclic voltammetry (CV) curves of the Cu_{2-x}SNWs based supercapacitor at different scan rates (from 5 mV·s⁻¹ to 2000 mV·s⁻¹) and (b) detail of the CV performed at 10 mV·s⁻¹. (c) Calculated specific capacitance of the supercapacitor at different scan rates. (d) CV of the supercapacitor at the 1st and 5000th cycle (scan rate: 100 mV·s⁻¹).

4 Conclusions

In summary, we have demonstrated that ultralong copper nanowires (CuNWs) can be converted into copper sulfide nanowires (Cu_{2-x}SNWs) maintaining the high aspect ratio by sulphidation in ethanolic solution employing thiourea as sulfur source. The multiscale characterization of Cu_{2-x}SNWs by means of XRD, TEM, EDX and XPS, revealed that after sulphidation a core shell structure is obtained with the outer core being composed by covellite and the inner core by roxbyite. The obtained Cu_{2-x}SNWs could be readily dispersed in ethanol and be directly deposited by spray-coating onto glass or plastic substrate resulting in conductive films without the need of any post deposition process. Because of the high aspect ratio of the synthesized Cu_{2-x}SNWs, films deposited on glass revealed a sheet resistance as low as 4.1 k Ω /sq at 73.7 % transmittance (measured at 550 nm), which can be further halved after annealing of the film at 190 °C for 30 min. The film possesses an improved chemical stability in presence of copper etchants such as FeCl₃, as well as in acidic conditions. Bending tests have also shown a remarkable stability with an increase of the resistance of only 4.4 % after 10000 bending cycles. The electronic conductivity of the material has been determined not only on the film as a function of light transmission, but also in the bulk and at a single nanowire level. The latest exhibited a perfect Ohmic conductivity with a resistivity of $6.9 \times 10^{-6} \Omega$ m. Finally, the performance of the material in a symmetric supercapacitor has been evaluated. The Cu_{2-x}SNWs presented a pseudocapacitive behavior, with a high specific capacity of 324 F·g⁻¹ and an ultrahigh volumetric capacity of 60.5 F·cm⁻³ at scan rates of 5 mV·s⁻¹. The supercapacitor also revealed a moderate capacity retention after 5000 cycles of operation at 100 mV·s⁻¹ (70 % of the original capacitance). Our results suggest that Cu_{2-x}SNWs can be used for printed, flexible electronics while their use as transparent electrodes still require an improvement of the conductivity to be comparable with metallic CuNWs.

Conflicts of interest

The authors declare no competing financial interest.

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